



CALL FOR PAPERS

Phase Stability, Phase Transformations, and Reactive Phase Formation in Electronic Materials XI

The 141th TMS Annual Meeting & Exhibition at Orlando, FL, USA
March 11-15, 2012

This is the eleventh in a series of TMS symposia addressing the stability, transformation, and formation of phases during the fabrication, processing, and utilization of electronic (optoelectronic) materials and devices. Topics of interests include phase stability issues surrounding microelectronics packaging technology, phase formation and integrated circuit technology, and the phase stability and morphological evolution of novel electronic (optoelectronic) materials.

Abstracts are due by July 15, 2011. Please submit abstracts directly to TMS Online. Individuals without access to the Web may submit the abstracts to the organizers. This symposium will have a special issue in Journal of Electronic Materials. If you wish your paper to be considered for publication in the special issue, please submit the manuscripts via journal website before April 30, 2012.

Organizers

- Chih-Ming Chen** National Chung Hsing University
Department of Chemical Engineering, Taichung, Taiwan
Tel: +886-4-2285-9458, Fax: +886-4-2285-4734, E-mail: chenmc@nchu.edu.tw
- Jae-Ho Lee** Hongik University
Department of Materials Science and Engineering, Seoul, Korea
Tel: +82-2-320-1081, Fax: +82-2-320-1019, E-mail: jhlee@hongik.ac.kr
- Ikuo Ohnuma** Tohoku University
Department of Metallurgy, Sendai, Japan
Tel: +81 22-795-7322, Fax: +81 22-795-7322, E-mail: ohnuma@material.tohoku.ac.jp
- Clemens Schmetterer** TU Bergakademie Freiberg
Virtuhcon, Freiberg, Germany
Tel: +49 3731 39 4812, Fax: +49 3731 39 4555
E-mail: clemens.schmetterer@vtc.tu-freiberg.de
- Yee-Wen Yen** National Taiwan University of Science and Technology
Department of Materials Science & Technology, Taipei, Taiwan
Tel: +886-22737-6659, Fax: +886-22737-6799, E-mail: ywye@mail.ntust.edu.tw
- Shih-Kang Lin** University of Wisconsin – Madison
Department of Materials Science and Engineering, Madison, WI, USA
Tel: +1-608-265-5502, Fax: +1-608-262-8353, E-mail: slin@cae.wisc.edu

TMS 2012: Linking Science and Technology for Global Solutions